

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-60V	4.2Ω@-10V	-130mA
	4.5Ω@-4.5V	


**合肥矽普半导体**
*Siliup Semiconductor Technology Co.Ltd*

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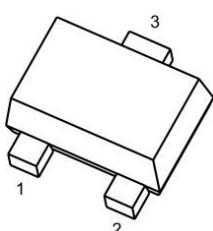
## Feature

- High power and current handing capability
- Surface mount package
- ESD Protected 2KV

## Application

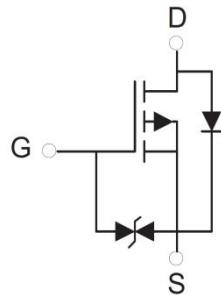
- Battery Switch
- DC/DC Converter

## Package

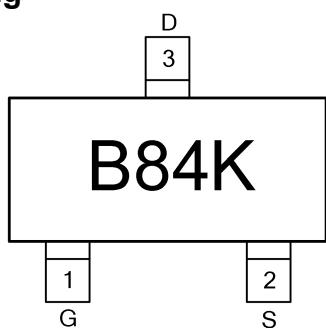


SOT-723

## Circuit diagram



## Marking



B84K

:Device Code

## Order Information

Device	Package	Unit/Tape
BSS84KT7	SOT-723	8000

**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-60	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	-130	mA
Pulse Drain Current Tested	I <sub>DM</sub>	-520	mA
Power Dissipation	P <sub>D</sub>	150	mW
Thermal Resistance Junction-to-Ambient	R <sub>θJA</sub>	833	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55 to 150	°C

**Electrical characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V , ID=-250μA	-60	-	-	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>D</sub> =-48V , V <sub>GS</sub> =0V	-	-	1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V , V <sub>D</sub> =0V	-	-	±10	uA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>D</sub> =V <sub>GS</sub> , ID=-250μA	-0.8	-1.5	-2.5	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, ID=-150mA	-	4.2	6	Ω
		V <sub>GS</sub> =-4.5V, ID=-150mA	-	4.5	7	
<b>Dynamic characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>D</sub> =-5V , V <sub>GS</sub> =0V , f=1MHz	-	30	-	pF
Output Capacitance	C <sub>oss</sub>		-	10	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	5	-	
Total Gate Charge	Q <sub>g</sub>	V <sub>D</sub> =-30V , V <sub>GS</sub> =-10V , ID=-0.15A	-	1.8	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	0.5	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	0.18	-	
<b>Switching Characteristics</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>D</sub> =-15V V <sub>GS</sub> =-10V , RG=50Ω, ID=-0.15A	-	8.6	-	nS
Turn-On Rise Time	t <sub>r</sub>		-	20	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	14	-	
Turn-Off Fall Time	t <sub>f</sub>		-	77	-	
<b>Source-Drain Diode characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V , IS=-1A , TJ=25°C	-	-	-1.2	V



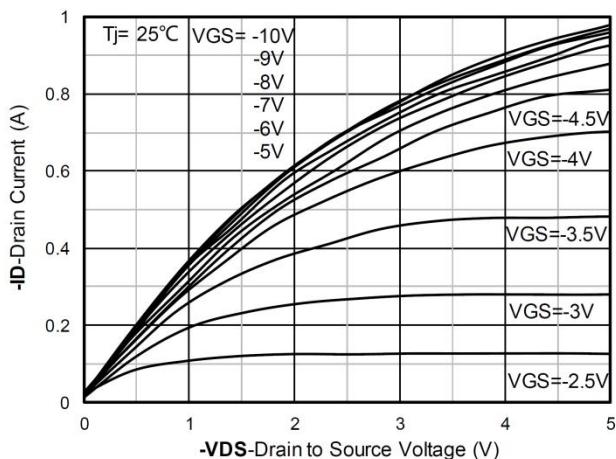
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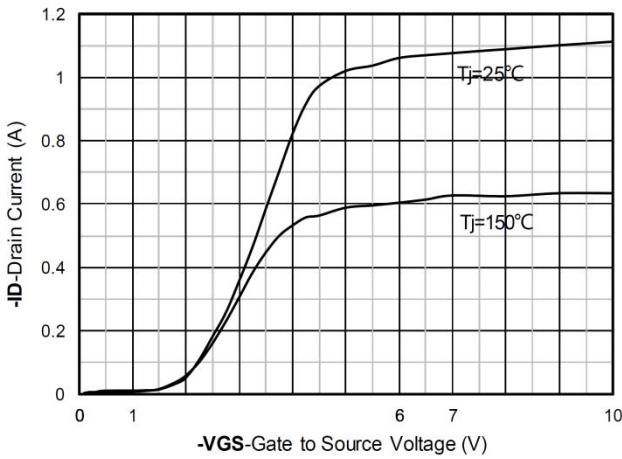
**BSS84KT7**

60V P-Channel MOSFET

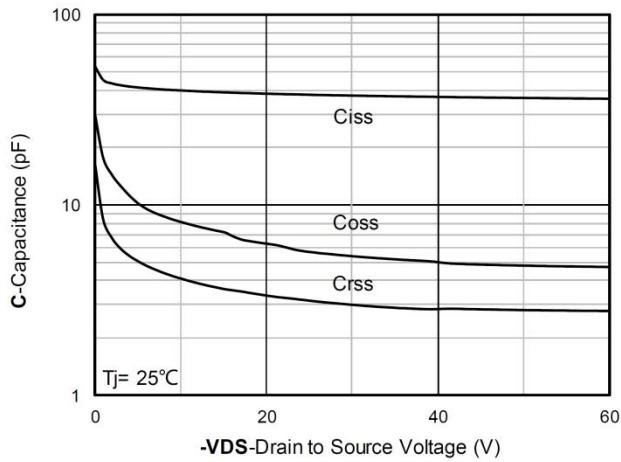
## Typical Characteristics



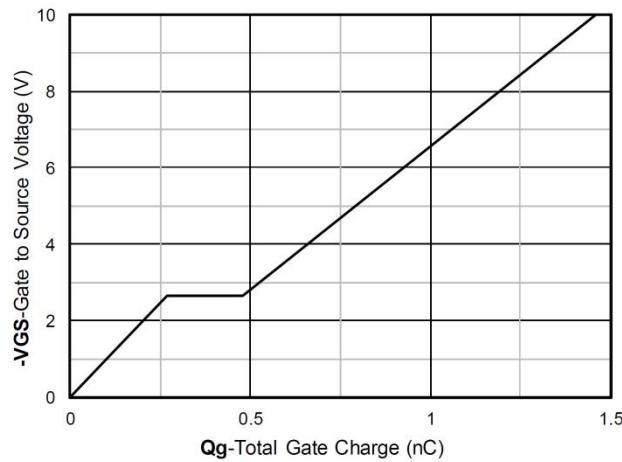
Output Characteristics



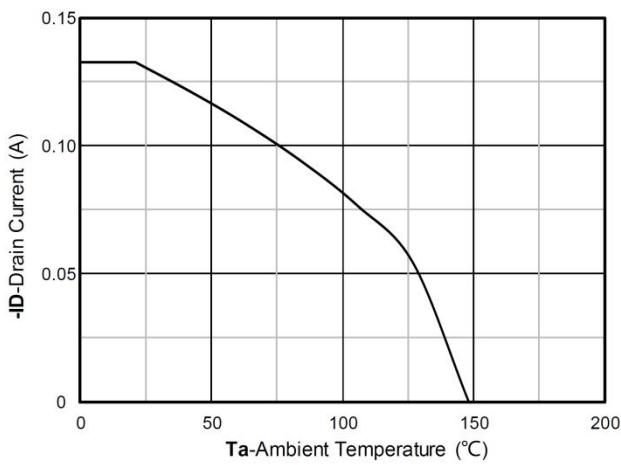
Transfer Characteristics



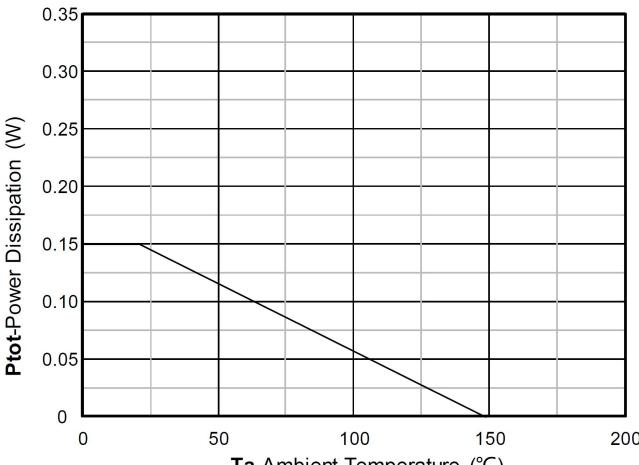
Capacitance Characteristics



Gate Charge



Current dissipation



Power dissipation

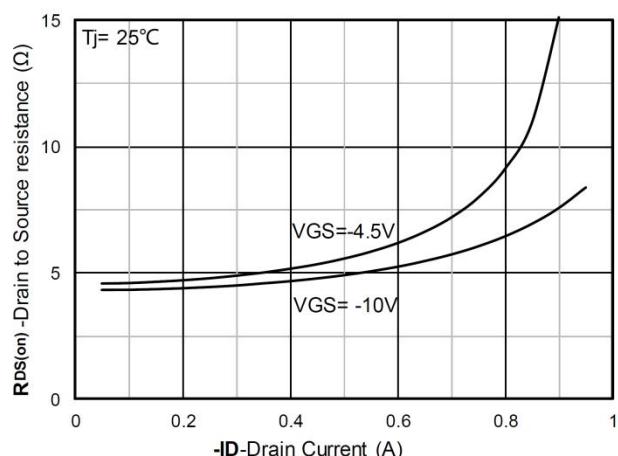


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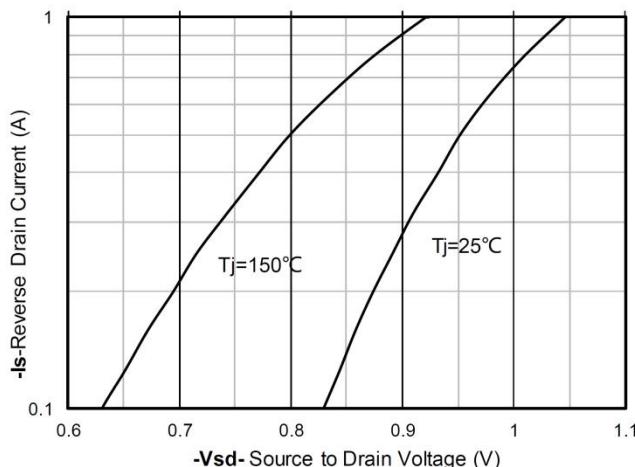
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**BSS84KT7**

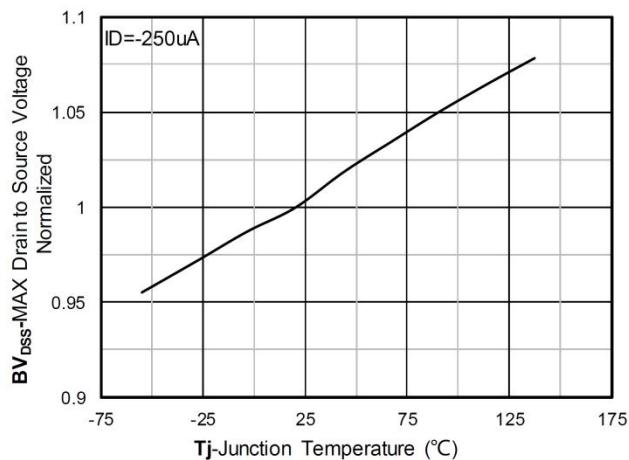
**60V P-Channel MOSFET**



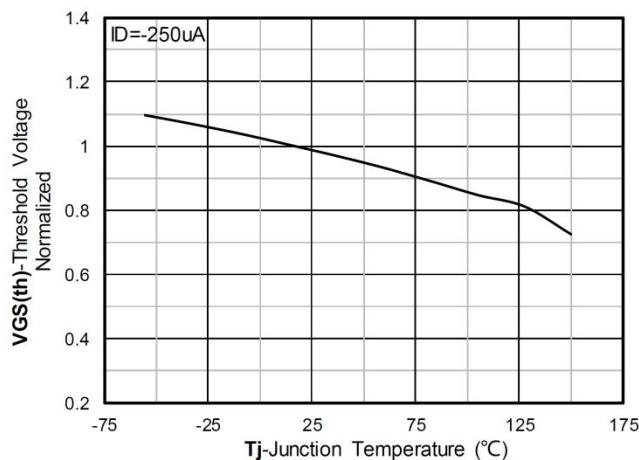
RDS(on) VS Drain Current



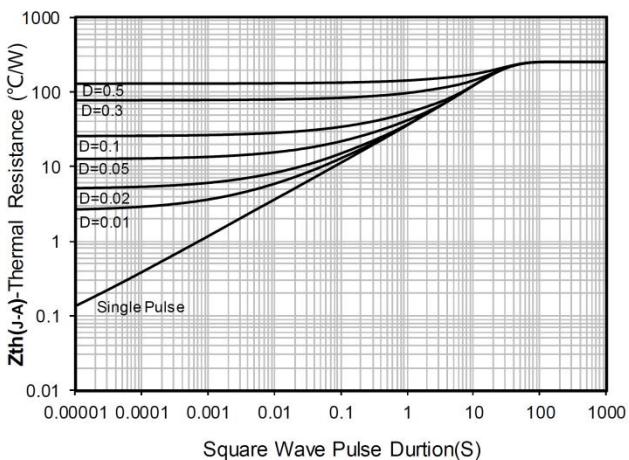
Forward characteristics of reverse diode



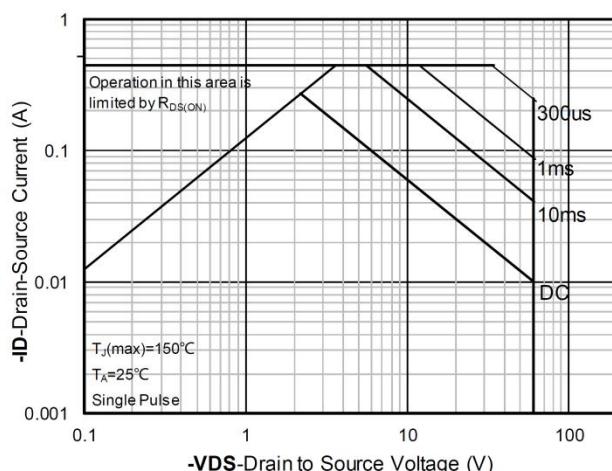
Normalized breakdown voltage



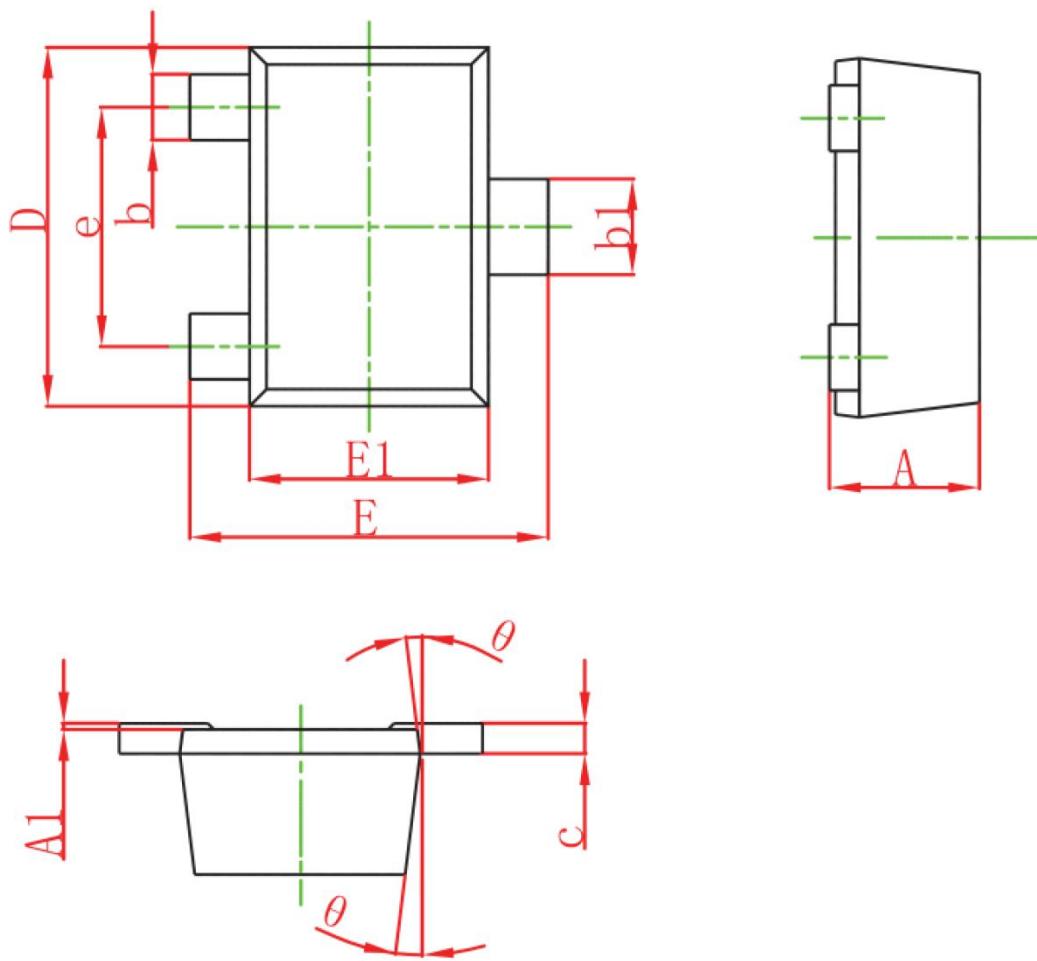
Normalized Threshold voltage



Maximum Transient Thermal Impedance



Safe Operation Area

**SOT-723 Package Information**


Symbol	Dimensions In Millimeters	
	Min	Max
A	0.430	0.500
A1	0.000	0.050
b	0.170	0.270
b1	0.270	0.370
C	0.080	0.150
D	1.150	1.250
E	1.150	1.250
E1	0.750	0.850
e	0.800 Typ.	
$\theta$	7°Ref.	